## DM37x Design Network Partners

Category	Expertise	Customer	Specialty	Region	Contact
SW development	Multi media	Collabora	Provider of consulting, development and	UK	Robert McQueen
	G-Streamer		training for Gstreamer		[robert.mcqueen@collabora.co.uk]
SW development	System SW	<u>Adeneo</u>	Windows Embedded, BSP/EVM	EU - France, AM	CHAMMINGS Yannick [ychammings@adeneo-
	OS (Windows/Android)				embedded.com]
SW development	System SW	Sasken	Android and Multimedia	WW	Prashanth Bhushan
					[Prashanth.bhushan@sasken.com]
SW development	OS (Windows)	MPC Data	Complete Windows Embedded and Linux	UK, AM	Morten Iversen
	M3 customization for		bring-up		[morteni@bsquare.com]
	HDVPSS and ISS		M3 source code for customization		
SW development	Multi media	SolDel Group	Complete Linux bring-up, G-Streamer	UK	Christian Pennycate [cjp@soldelgroup.com]
	G-Streamer				
SW development	Codecs	<u>Ittiam</u>	Video Infrastructure	France / India	Denis Castaing [denis.castaing@ittiam.com]
SW development	Codecs	Path Partner	Video and Vision applications	India	Ramkishor Korada
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HW&SW development	HW/SW development	<u>Mistral</u>	HW and SW development	USA/India	Samyeer Metrani
					[samyeer@mistralsolutions.com]
Modules	DM3730	CUPP	HW modules	Norway	Omar Nathaniel Ely
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Modules	OMAP44xx	Variscite	Modules + Linux/Android BSP	WW	[sales@variscite.com]
Modules	DM3730	LogicPD	HW modules	WW	Mike Tackaberry
					[tack@logicpd.com]
Modules	DM3730	<u>Gumstix</u>	HW modules	WW	Don Anderson
					[don@gumstix.com]
Modules	OMAP44xx	Variscite	Modules + Linux/Android BSP	WW	[sales@variscite.com]
EDH/EMS	OS (Linux), System	<u>Benchmark</u>	Benchmark is a world-leading, top-10 EMS	Netherlands,	Martin Lutke Schipholt
	Development and		company.	Romania, USA	[Martin.Lutke.Schipholt@bench.com]
	productisation				

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